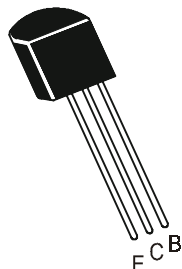


PNP SILICON PLANAR EPITAXIAL TRANSISTORS

CSA673
CSA673A

TO-92
Plastic Package



Complementary CSC1213 and CSC1213A

Low Frequency Amplifier, Medium Speed Switching

ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	CSA673	CSA673A	UNIT
Collector Emitter Voltage	V_{CEO}	35	50	V
Collector Base Voltage	V_{CBO}	35	50	V
Emitter Base Voltage	V_{EBO}	4	4	V
Collector Current	I_C	500	500	mA
Collector Power Dissipation	P_C	400	400	mW
Operating And Storage Junction Temperature Range	T_j, T_{stg}	-55 to +150	-55 to +150	°C

ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	CSA673	CSA673A	UNIT
Collector Emitter Voltage	BV_{CEO}	$I_C=1mA, I_B=0$	>35	>50	V
Collector Base Voltage	V_{CBO}	$I_C=10\mu A, I_E=0$	>35	>50	V
Emitter Base Voltage	V_{EBO}	$I_E=10\mu A, I_C=0$	>4	>4	V
Collector Cut off Current	I_{CBO}	$V_{CB}=20V, I_E=0$	<500	<500	nA
Collector Emitter Saturation Voltage	$V_{CE(sat)}^{**}$	$I_C=150mA, I_B=15mA$	<0.6	<0.6	V
DC Current Gain	h_{FE}^*	$V_{CE}=3V, I_C=10mA$	60 - 320	60 - 320	
		$V_{CE}=3V, I_C=500mA^{**}$	>10	>10	
Base Emitter Voltage	V_{BE}	$V_{CE}=3V, I_C=10mA$	typ 0.64	typ 0.64	V

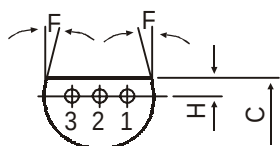
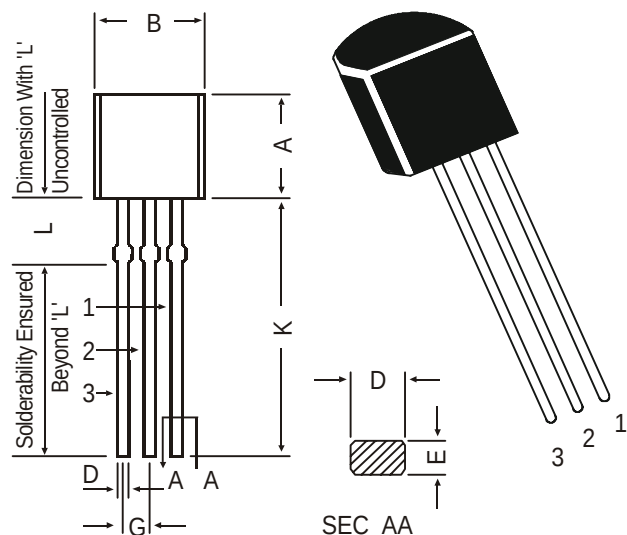
Classification

	B	C	D
h_{FE}^*	60 - 120	100 - 200	160 - 320

**Pulse Test

TO-92 Plastic Package

TO-92 Transistors on Tape and Ammo Pack

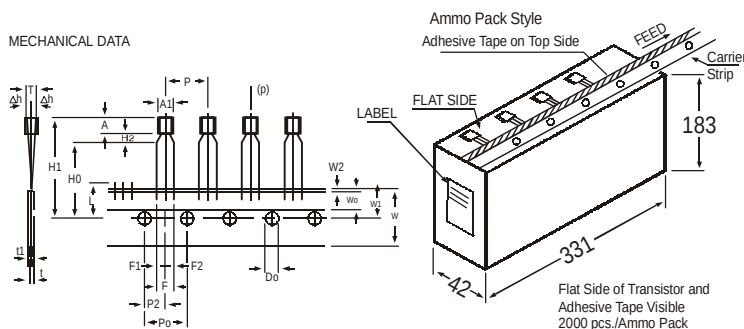


PIN CONFIGURATION

1. BASE
2. COLLECTOR
3. EMITTER

DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.14	1.53
K	12.70	—
L	1.982	2.082

All dimensions in mm.



All dimensions in mm unless specified otherwise

ITEM	SYMBOL	SPECIFICATION				REMARKS
		MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH TO BE MEASURED AT BOTTOM OF CLINCH
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		±1	
FEED HOLE PITCH	Po		12.7		±0.3	
FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		±0.4	AT TOP OF BODY
DISTANCE BETWEEN OUTER LEADS	F		5.08		+0.6 -0.2	
COMPONENT ALIGNMENT	Δh		0	1		
TAPE WIDTH	W		18		±0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		±0.2	
HOLE POSITION	W1		9		+0.7 -0.5	±0.3 - 0.6
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		±0.5	
COMPONENT HEIGHT	H1		23.25			
LENGTH OF SNIPPED LEADS	L		11.0			
FEED HOLE DIAMETER	Do		4		±0.2	
TOTAL TAPE THICKNESS	t		1.2			
LEAD - TO - LEAD DISTANCE F1,	F2		2.54		+0.4 -0.1	
CLINCH HEIGHT	H2		3			
PULL - OUT FORCE	(P)	6N				

NOTES

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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